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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

| Details | |
|--------------------------------|---|
| Product Status | Active |
| Number of LABs/CLBs | 339620 |
| Number of Logic Elements/Cells | 900000 |
| Total RAM Bits | 59234304 |
| Number of I/O | 768 |
| Number of Gates | - |
| Voltage - Supply | 0.87V ~ 0.98V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 100°C (TJ) |
| Package / Case | 1932-BBGA, FCBGA |
| Supplier Device Package | 1932-FCBGA (45x45) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/10ax090n2f45e1sg |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



| Feature | | Description | | | |
|--|--|--|--|--|--|
| Low-power serial transceivers | - Intel Arria 10 GT- Backplane support: - Intel Arria 10 GX- Intel Arria 10 GT- Extended range dow ATX transmit PLLs w Electronic Dispersion module Adaptive linear and of | —1 Gbps to 17.4 Gbps —1 Gbps to 25.8 Gbps —up to 12.5 | | | |
| HPS (Intel Arria 10 SX devices only) | Processor and system | Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability 256 KB on-chip RAM and 64 KB on-chip ROM System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA) ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage | | | |
| | External interfaces | Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-GO (OTG) controllers, I²C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os) | | | |
| | Interconnects to core | High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller | | | |
| Configuration | Enhanced 256-bit ad | comprehensive design protection to protect your valuable IP investments dvanced encryption standard (AES) design security with authentication obtocol (CvP) using PCIe Gen1, Gen2, or Gen3 | | | |
| | | continued | | | |

 $^{^{(2)}}$ Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



| Feature | Description |
|--------------------|--|
| | Dynamic reconfiguration of the transceivers and PLLs Fine-grained partial reconfiguration of the core fabric Active Serial x4 Interface |
| Power management | SmartVID Low static power device options Programmable Power Technology Intel Quartus Prime integrated power analysis |
| Software and tools | Intel Quartus Prime design suite Transceiver toolkit Platform Designer system integration tool DSP Builder for Intel FPGAs OpenCL™ support Intel SoC FPGA Embedded Design Suite (EDS) |

Related Information

Intel Arria 10 Transceiver PHY Overview

Provides details on Intel Arria 10 transceivers.

Intel Arria 10 Device Variants and Packages

Table 4. **Device Variants for the Intel Arria 10 Device Family**

| Variant | Description |
|-------------------|---|
| Intel Arria 10 GX | FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |
| Intel Arria 10 GT | FPGA featuring: 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. 25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules. |
| Intel Arria 10 SX | SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |

Intel Arria 10 GX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.



Table 6. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 570, GX 660, GX 900, and GX 1150)

| Re | source | | Produc | t Line | |
|------------------------------|-------------------------|---------|-----------|-----------|-----------|
| | | GX 570 | GX 660 | GX 900 | GX 1150 |
| Logic Elements | s (LE) (K) | 570 | 660 | 900 | 1,150 |
| ALM | | 217,080 | 251,680 | 339,620 | 427,200 |
| Register | | 868,320 | 1,006,720 | 1,358,480 | 1,708,800 |
| Memory (Kb) | M20K | 36,000 | 42,620 | 48,460 | 54,260 |
| | MLAB | 5,096 | 5,788 | 9,386 | 12,984 |
| Variable-precision DSP Block | | 1,523 | 1,687 | 1,518 | 1,518 |
| 18 x 19 Multip | lier | 3,046 | 3,374 | 3,036 | 3,036 |
| PLL | Fractional Synthesis | 16 | 16 | 32 | 32 |
| | I/O | 16 | 16 | 16 | 16 |
| 17.4 Gbps Trai | nsceiver | 48 | 48 | 96 | 96 |
| GPIO (3) | | 696 | 696 | 768 | 768 |
| LVDS Pair (4) | | 324 | 324 | 384 | 384 |
| PCIe Hard IP E | Block | 2 | 2 | 4 | 4 |
| Hard Memory | Controller | 16 | 16 | 16 | 16 |

Package Plan

Table 7. Package Plan for Intel Arria 10 GX Devices (U19, F27, and F29)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | U19 (19 mm × 19 mm, 484-pin UBGA) | | | | F27 mm × 27 n 72-pin FBG/ | | F29 (29 mm × 29 mm, 780-pin FBGA) | | |
|--------------|---|----------|------|---------|---------------------------------|------|---|----------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| GX 160 | 48 | 192 | 6 | 48 | 192 | 12 | 48 | 240 | 12 |
| GX 220 | 48 | 192 | 6 | 48 | 192 | 12 | 48 | 240 | 12 |
| GX 270 | _ | _ | _ | 48 | 192 | 12 | 48 | 312 | 12 |
| GX 320 | _ | _ | _ | 48 | 192 | 12 | 48 | 312 | 12 |
| GX 480 | _ | _ | _ | _ | _ | _ | 48 | 312 | 12 |



Table 8. Package Plan for Intel Arria 10 GX Devices (F34, F35, NF40, and KF40)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | F34 (35 mm × 35 mm, 1152-pin FBGA) | | | F35 (35 mm × 35 mm, 1152-pin FBGA) | | KF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF40 (40 mm × 40 mm, 1517-pin FBGA) | | | |
|--------------|--|-------------|------|--|-------------|---|------------|-------------|---|------------|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| GX 270 | 48 | 336 | 24 | 48 | 336 | 24 | _ | _ | _ | _ | _ | _ |
| GX 320 | 48 | 336 | 24 | 48 | 336 | 24 | _ | _ | _ | _ | _ | _ |
| GX 480 | 48 | 444 | 24 | 48 | 348 | 36 | _ | _ | _ | _ | _ | - |
| GX 570 | 48 | 444 | 24 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |
| GX 660 | 48 | 444 | 24 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |
| GX 900 | _ | 504 | 24 | _ | _ | _ | _ | _ | _ | _ | 600 | 48 |
| GX 1150 | _ | 504 | 24 | _ | _ | _ | _ | _ | _ | _ | 600 | 48 |

Table 9. Package Plan for Intel Arria 10 GX Devices (RF40, NF45, SF45, and UF45)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | RF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF45 (45 mm × 45 mm) 1932-pin FBGA) | | | SF45 (45 mm × 45 mm) 1932-pin FBGA) | | | UF45 (45 mm × 45 mm) 1932-pin FBGA) | | |
|--------------|---|-------------|------|---|-------------|------|---|-------------|------|---|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR |
| GX 900 | _ | 342 | 66 | _ | 768 | 48 | - | 624 | 72 | _ | 480 | 96 |
| GX 1150 | _ | 342 | 66 | _ | 768 | 48 | ı | 624 | 72 | ı | 480 | 96 |

Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

Intel Arria 10 GT

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GT devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.



I/O Vertical Migration for Intel Arria 10 Devices

Figure 4. Migration Capability Across Intel Arria 10 Product Lines

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use
 memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to
 banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
- Some migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

| Variant | Product | | | | | | Package | e | | | | |
|---------------------|---------|----------|----------|----------|----------|----------|----------|----------|------|------|----------|----------|
| Varialit | Line | U19 | F27 | F29 | F34 | F35 | KF40 | NF40 | RF40 | NF45 | SF45 | UF45 |
| | GX 160 | 1 | 1 | 1 | | | | | | | | |
| | GX 220 | + | | | | | | | | | | |
| | GX 270 | | | | 1 | 1 | | | | | | |
| | GX 320 | | V | | | | | | | | | |
| Intel® Arria® 10 GX | GX 480 | | | V | | | | | | | | |
| | GX 570 | | | | | | 1 | 1 | | | | |
| | GX 660 | | | | | V | \ | | | | | |
| | GX 900 | | | | | | | | 1 | 1 | | 1 |
| | GX 1150 | | | | V | | | + | + | + | | + |
| Intel Arria 10 GT | GT 900 | | | | | | | | | | | |
| intel Afria 10 G1 | GT 1150 | | | | | | | | | | V | |
| | SX 160 | 1 | 1 | 1 | | | | | | | | |
| | SX 220 | + | | | | | | | | | | |
| | SX 270 | | | | 1 | † | | | | | | |
| Intel Arria 10 SX | SX 320 | | V | | | | | | | | | |
| | SX 480 | | | V | | | | | | | | |
| | SX 570 | | | | | | † | † | | | | |
| | SX 660 | | | | * | | | | | | | |

Note:

To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

Adaptive Logic Module

Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.



| Variant | Product Line | Variable- precision | Independent In Multiplication | | 18 x 19 Multiplier | 18 x 18 Multiplier Adder | |
|---------|--------------|------------------------|----------------------------------|-----------------------|-----------------------|--------------------------------|--|
| | | DSP Block | 18 x 19 Multiplier | 27 x 27 Multiplier | Adder Sum Mode | Summed with 36 bit Input | |
| | SX 320 | 984 | 1,968 | 984 | 984 | 984 | |
| | SX 480 | 1,368 | 2,736 | 1,368 | 1,368 | 1,368 | |
| | SX 570 | 1,523 | 3,046 | 1,523 | 1,523 | 1,523 | |
| | SX 660 | 1,687 | 3,374 | 1,687 | 1,687 | 1,687 | |

Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

| Variant | Product Line | Variable- precision DSP Block | Single Precision Floating-Point Multiplication Mode | Single-Precision Floating-Point Adder Mode | Single- Precision Floating-Point Multiply Accumulate Mode | Peak Giga Floating- Point Operations per Second (GFLOPs) |
|----------------|--------------|-------------------------------------|---|--|--|--|
| Intel Arria 10 | GX 160 | 156 | 156 | 156 | 156 | 140 |
| GX | GX 220 | 192 | 192 | 192 | 192 | 173 |
| | GX 270 | 830 | 830 | 830 | 830 | 747 |
| | GX 320 | 984 | 984 | 984 | 984 | 886 |
| | GX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | GX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | GX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |
| | GX 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| | GX 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | GT 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| GT | GT 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | SX 160 | 156 | 156 | 156 | 156 | 140 |
| SX | SX 220 | 192 | 192 | 192 | 192 | 173 |
| | SX 270 | 830 | 830 | 830 | 830 | 747 |
| | SX 320 | 984 | 984 | 984 | 984 | 886 |
| | SX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | SX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | SX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



Embedded Memory Configurations for Single-port Mode

Table 19. Single-port Embedded Memory Configurations for Intel Arria 10 Devices

This table lists the maximum configurations supported for single-port RAM and ROM modes.

| Memory Block | Depth (bits) | Programmable Width |
|--------------|--------------|--------------------|
| MLAB | 32 | x16, x18, or x20 |
| | 64 (10) | x8, x9, x10 |
| M20K | 512 | x40, x32 |
| | 1K | x20, x16 |
| | 2K | x10, x8 |
| | 4K | x5, x4 |
| | 8K | x2 |
| | 16K | x1 |

Clock Networks and PLL Clock Sources

The clock network architecture is based on Intel's global, regional, and peripheral clock structure. This clock structure is supported by dedicated clock input pins, fractional clock synthesis PLLs, and integer I/O PLLs.

Clock Networks

The Intel Arria 10 core clock networks are capable of up to 800 MHz fabric operation across the full industrial temperature range. For the external memory interface, the clock network supports the hard memory controller with speeds up to 2,400 Mbps in a quarter-rate transfer.

To reduce power consumption, the Intel Quartus Prime software identifies all unused sections of the clock network and powers them down.

Fractional Synthesis and I/O PLLs

Intel Arria 10 devices contain up to 32 fractional synthesis PLLs and up to 16 I/O PLLs that are available for both specific and general purpose uses in the core:

- Fractional synthesis PLLs—located in the column adjacent to the transceiver blocks
- I/O PLLs-located in each bank of the 48 I/Os

Fractional Synthesis PLLs

You can use the fractional synthesis PLLs to:

- Reduce the number of oscillators that are required on your board
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

⁽¹⁰⁾ Supported through software emulation and consumes additional MLAB blocks.

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The fractional synthesis PLLs support the following features:

- Reference clock frequency synthesis for transceiver CMU and Advanced Transmit (ATX) PLLs
- Clock network delay compensation
- Zero-delay buffering
- Direct transmit clocking for transceivers
- Independently configurable into two modes:
 - Conventional integer mode equivalent to the general purpose PLL
 - Enhanced fractional mode with third order delta-sigma modulation
- PLL cascading

I/O PLLs

The integer mode I/O PLLs are located in each bank of 48 I/Os. You can use the I/O PLLs to simplify the design of external memory and high-speed LVDS interfaces.

In each I/O bank, the I/O PLLs are adjacent to the hard memory controllers and LVDS SERDES. Because these PLLs are tightly coupled with the I/Os that need to use them, it makes it easier to close timing.

You can use the I/O PLLs for general purpose applications in the core such as clock network delay compensation and zero-delay buffering.

Intel Arria 10 devices support PLL-to-PLL cascading.

FPGA General Purpose I/O

Intel Arria 10 devices offer highly configurable GPIOs. Each I/O bank contains 48 general purpose I/Os and a high-efficiency hard memory controller.

The following list describes the features of the GPIOs:

- Consist of 3 V I/Os for high-voltage application and LVDS I/Os for differential signaling
 - $-\$ Up to two 3 V I/O banks, available in some devices, that support up to 3 V I/O standards
 - LVDS I/O banks that support up to 1.8 V I/O standards
- Support a wide range of single-ended and differential I/O interfaces
- LVDS speeds up to 1.6 Gbps
- Each LVDS pair of pins has differential input and output buffers, allowing you to configure the LVDS direction for each pair.
- Programmable bus hold and weak pull-up
- Programmable differential output voltage (V_{OD}) and programmable pre-emphasis



Table 20. Memory Standards Supported by the Hard Memory Controller

This table lists the overall capability of the hard memory controller. For specific details, refer to the External Memory Interface Spec Estimator and Intel Arria 10 Device Datasheet.

| Memory Standard | Rate Support | Ping Pong PHY Support | Maximum Frequency (MHz) |
|-----------------|--------------|-----------------------|-------------------------|
| DDR4 SDRAM | Quarter rate | Yes | 1,067 |
| | | _ | 1,200 |
| DDR3 SDRAM | Half rate | Yes | 533 |
| | | _ | 667 |
| | Quarter rate | Yes | 1,067 |
| | | _ | 1,067 |
| DDR3L SDRAM | Half rate | Yes | 533 |
| | | _ | 667 |
| | Quarter rate | Yes | 933 |
| | | _ | 933 |
| LPDDR3 SDRAM | Half rate | _ | 533 |
| | Quarter rate | _ | 800 |

Table 21. Memory Standards Supported by the Soft Memory Controller

| Memory Standard | Rate Support | Maximum Frequency (MHz) |
|-----------------------------|--------------|----------------------------|
| RLDRAM 3 (11) | Quarter rate | 1,200 |
| QDR IV SRAM ⁽¹¹⁾ | Quarter rate | 1,067 |
| QDR II SRAM | Full rate | 333 |
| | Half rate | 633 |
| QDR II+ SRAM | Full rate | 333 |
| | Half rate | 633 |
| QDR II+ Xtreme SRAM | Full rate | 333 |
| | Half rate | 633 |

Table 22. Memory Standards Supported by the HPS Hard Memory Controller

The hard processor system (HPS) is available in Intel Arria 10 SoC devices only.

| Memory Standard | Rate Support | Maximum Frequency (MHz) |
|-----------------|--------------|----------------------------|
| DDR4 SDRAM | Half rate | 1,200 |
| DDR3 SDRAM | Half rate | 1,067 |
| DDR3L SDRAM | Half rate | 933 |

⁽¹¹⁾ Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.

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The scalable hard IP supports multiple independent 10GbE ports while using a single PLL for all the 10GBASE-R PCS instantiations, which saves on core logic resources and clock networks:

- Simplifies multiport 10GbE systems compared to XAUI interfaces that require an external XAUI-to-10G PHY.
- Incorporates Electronic Dispersion Compensation (EDC), which enables direct connection to standard 10 Gbps XFP and SFP+ pluggable optical modules.
- Supports backplane Ethernet applications and includes a hard 10GBASE-KR Forward Error Correction (FEC) circuit that you can use for 10 Gbps and 40 Gbps applications.

The 10 Gbps Ethernet PCS hard IP and 10GBASE-KR FEC are present in every transceiver channel.

Related Information

PCS Features on page 30

Low Power Serial Transceivers

Intel Arria 10 FPGAs and SoCs include lowest power transceivers that deliver high bandwidth, throughput and low latency.

Intel Arria 10 devices deliver the industry's lowest power consumption per transceiver channel:

- 12.5 Gbps transceivers at as low as 242 mW
- 10 Gbps transceivers at as low as 168 mW
- 6 Gbps transceivers at as low as 117 mW

Intel Arria 10 transceivers support various data rates according to application:

- Chip-to-chip and chip-to-module applications—from 1 Gbps up to 25.8 Gbps
- Long reach and backplane applications—from 1 Gbps up to 12.5 with advanced adaptive equalization
- Critical power sensitive applications—from 1 Gbps up to 11.3 Gbps using lower power modes

The combination of 20 nm process technology and architectural advances provide the following benefits:

- Significant reduction in die area and power consumption
- Increase of up to two times in transceiver I/O density compared to previous generation devices while maintaining optimal signal integrity
- Up to 72 total transceiver channels—you can configure up to 6 of these channels to run as fast as 25.8 Gbps
- All channels feature continuous data rate support up to the maximum rated speed







Transceiver Channels

All transceiver channels feature a dedicated Physical Medium Attachment (PMA) and a hardened Physical Coding Sublayer (PCS).

- The PMA provides primary interfacing capabilities to physical channels.
- The PCS typically handles encoding/decoding, word alignment, and other preprocessing functions before transferring data to the FPGA core fabric.

A transceiver channel consists of a PMA and a PCS block. Most transceiver banks have 6 channels. There are some transceiver banks that contain only 3 channels.

A wide variety of bonded and non-bonded data rate configurations is possible using a highly configurable clock distribution network. Up to 80 independent transceiver data rates can be configured.

The following figures are graphical representations of top views of the silicon die, which correspond to reverse views for flip chip packages. Different Intel Arria 10 devices may have different floorplans than the ones shown in the figures.





| PCS | Description |
|---------------|--|
| Standard PCS | Operates at a data rate up to 12 Gbps Supports protocols such as PCI-Express, CPRI 4.2+, GigE, IEEE 1588 in Hard PCS Implements other protocols using Basic/Custom (Standard PCS) transceiver configuration rules. |
| Enhanced PCS | Performs functions common to most serial data industry standards, such as word alignment, encoding/decoding, and framing, before data is sent or received off-chip through the PMA Handles data transfer to and from the FPGA fabric Handles data transfer internally to and from the PMA Provides frequency compensation Performs channel bonding for multi-channel low skew applications |
| PCIe Gen3 PCS | Supports the seamless switching of Data and Clock between the Gen1, Gen2, and Gen3 data rates Provides support for PIPE 3.0 features Supports the PIPE interface with the Hard IP enabled, as well as with the Hard IP bypassed |

Related Information

- PCIe Gen1, Gen2, and Gen3 Hard IP on page 26
- Interlaken Support on page 26
- 10 Gbps Ethernet Support on page 26

PCS Protocol Support

This table lists some of the protocols supported by the Intel Arria 10 transceiver PCS. For more information about the blocks in the transmitter and receiver data paths, refer to the related information.

| Protocol | Data Rate (Gbps) | Transceiver IP | PCS Support |
|--|---------------------|-----------------------------|-----------------------------------|
| PCIe Gen3 x1, x2, x4, x8 | 8.0 | Native PHY (PIPE) | Standard PCS and PCIe Gen3 PCS |
| PCIe Gen2 x1, x2, x4, x8 | 5.0 | Native PHY (PIPE) | Standard PCS |
| PCIe Gen1 x1, x2, x4, x8 | 2.5 | Native PHY (PIPE) | Standard PCS |
| 1000BASE-X Gigabit Ethernet | 1.25 | Native PHY | Standard PCS |
| 1000BASE-X Gigabit Ethernet with IEEE 1588v2 | 1.25 | Native PHY | Standard PCS |
| 10GBASE-R | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-R with IEEE 1588v2 | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-R with KR FEC | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-KR and 1000BASE-X | 10.3125 | 1G/10GbE and 10GBASE-KR PHY | Standard PCS and Enhanced PCS |
| Interlaken (CEI-6G/11G) | 3.125 to 17.4 | Native PHY | Enhanced PCS |
| SFI-S/SFI-5.2 | 11.2 | Native PHY | Enhanced PCS |
| 10G SDI | 10.692 | Native PHY | Enhanced PCS |
| | • | | continued |



| Protocol | Data Rate (Gbps) | Transceiver IP | PCS Support |
|----------------------|-------------------------------|----------------|--------------|
| CPRI 6.0 (64B/66B) | 0.6144 to 10.1376 | Native PHY | Enhanced PCS |
| CPRI 4.2 (8B/10B) | 0.6144 to 9.8304 | Native PHY | Standard PCS |
| OBSAI RP3 v4.2 | 0.6144 to 6.144 | Native PHY | Standard PCS |
| SD-SDI/HD-SDI/3G-SDI | 0.143 ⁽¹²⁾ to 2.97 | Native PHY | Standard PCS |

Related Information

Intel Arria 10 Transceiver PHY User Guide

Provides more information about the supported transceiver protocols and PHY IP, the PMA architecture, and the standard, enhanced, and PCIe Gen3 PCS architecture.

SoC with Hard Processor System

Each SoC device combines an FPGA fabric and a hard processor system (HPS) in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

⁽¹²⁾ The 0.143 Gbps data rate is supported using oversampling of user logic that you must implement in the FPGA fabric.



Table 24. **Improvements in 20 nm HPS**

This table lists the key improvements of the 20 nm HPS compared to the 28 nm HPS.

| Advantages/ Improvements | Description |
|---|--|
| Increased performance and overdrive capability | While the nominal processor frequency is 1.2 GHz, the 20 nm HPS offers an "overdrive" feature which enables a higher processor operating frequency. This requires a higher supply voltage value that is unique to the HPS and may require a separate regulator. |
| Increased processor memory bandwidth and DDR4 support | Up to 64-bit DDR4 memory at 2,400 Mbps support is available for the processor. The hard memory controller for the HPS comprises a multi-port front end that manages connections to a single port memory controller. The multi-port front end allows logic core and the HPS to share ports and thereby the available bandwidth of the memory controller. |
| Flexible I/O sharing | An advanced I/O pin muxing scheme allows improved sharing of I/O between the HPS and the core logic. The following types of I/O are available for SoC: 17 dedicated I/Os—physically located inside the HPS block and are not accessible to logic within the core. The 17 dedicated I/Os are used for HPS clock, resets, and interfacing with boot devices, QSPI, and SD/MMC. 48 direct shared I/O—located closest to the HPS block and are ideal for high speed HPS peripherals such as EMAC, USB, and others. There is one bank of 48 I/Os that supports direct sharing where the 48 I/Os can be shared 12 I/Os at a time. Standard (shared) I/O—all standard I/Os can be shared by the PPS peripherals and any logic within the core. For designs where more than 48 I/Os are required to fully use all the peripherals in the HPS, these I/Os can be connected through the core logic. |
| EMAC core | Three EMAC cores are available in the HPS. The EMAC cores enable an application to support two redundant Ethernet connections; for example, backplane, or two EMAC cores for managing IEEE 1588 time stamp information while allowing a third EMAC core for debug and configuration. All three EMACs can potentially share the same time stamps, simplifying the 1588 time stamping implementation. A new serial time stamp interface allows core logic to access and read the time stamp values. The integrated EMAC controllers can be connected to external Ethernet PHY through the provided MDIO or I ² C interface. |
| On-chip memory | The on-chip memory is updated to 256 KB support and can support larger data sets and real time algorithms. |
| ECC enhancements | Improvements in L2 Cache ECC management allow identification of errors down to the address level. ECC enhancements also enable improved error injection and status reporting via the introduction of new memory mapped access to syndrome and data signals. |
| HPS to FPGA Interconnect Backbone | Although the HPS and the Logic Core can operate independently, they are tightly coupled via a high-bandwidth system interconnect built from high-performance ARM AMBA AXI bus bridges. IP bus masters in the FPGA fabric have access to HPS bus slaves via the FPGA-to-HPS interconnect. Similarly, HPS bus masters have access to bus slaves in the core fabric via the HPS-to-FPGA bridge. Both bridges are AMBA AXI-3 compliant and support simultaneous read and write transactions. Up to three masters within the core fabric can share the HPS SDRAM controller with the processor. Additionally, the processor can be used to configure the core fabric under program control via a dedicated 32-bit configuration port. |
| FPGA configuration and HPS booting | The FPGA fabric and HPS in the SoCs are powered independently. You can reduce the clock frequencies or gate the clocks to reduce dynamic power. You can configure the FPGA fabric and boot the HPS independently, in any order, providing you with more design flexibility. |
| Security | New security features have been introduced for anti-tamper management, secure boot, encryption (AES), and authentication (SHA). |



System Peripherals and Debug Access Port

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

HPS-FPGA AXI Bridges

The HPS-FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA) Advanced eXtensible Interface (AXI $^{\text{\tiny M}}$) specifications, consist of the following bridges:

- FPGA-to-HPS AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA Avalon/AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows
 the HPS to issue transactions to soft peripherals in the FPGA fabric. This bridge is
 primarily used for control and status register (CSR) accesses to peripherals in the
 FPGA fabric.

The HPS-FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS-FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

HPS SDRAM Controller Subsystem

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

The HPS SDRAM controller supports up to 3 masters (command ports), 3x 64-bit read data ports and 3x 64-bit write data ports.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features.



FPGA Configuration and HPS Booting

The FPGA fabric and HPS in the SoC FPGA must be powered at the same time. You can reduce the clock frequencies or gate the clocks to reduce dynamic power.

Once powered, the FPGA fabric and HPS can be configured independently thus providing you with more design flexibility:

- You can boot the HPS independently. After the HPS is running, the HPS can fully or
 partially reconfigure the FPGA fabric at any time under software control. The HPS
 can also configure other FPGAs on the board through the FPGA configuration
 controller.
- Configure the FPGA fabric first, and then boot the HPS from memory accessible to the FPGA fabric.

Hardware and Software Development

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer system integration tool in the Intel Quartus Prime software.

For software development, the ARM-based SoC FPGA devices inherit the rich software development ecosystem available for the ARM Cortex-A9 MPCore processor. The software development process for Intel SoC FPGAs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux*, VxWorks*, and other operating systems are available for the SoC FPGAs. For more information on the operating systems support availability, contact the Intel FPGA sales team.

You can begin device-specific firmware and software development on the Intel SoC FPGA Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

Dynamic and Partial Reconfiguration

The Intel Arria 10 devices support dynamic and partial reconfiguration. You can use dynamic and partial reconfiguration simultaneously to enable seamless reconfiguration of both the device core and transceivers.

Dynamic Reconfiguration

You can reconfigure the PMA and PCS blocks while the device continues to operate. This feature allows you to change the data rates, protocol, and analog settings of a channel in a transceiver bank without affecting on-going data transfer in other transceiver banks. This feature is ideal for applications that require dynamic multiprotocol or multirate support.

Partial Reconfiguration

Using partial reconfiguration, you can reconfigure some parts of the device while keeping the device in operation.



Instead of placing all device functions in the FPGA fabric, you can store some functions that do not run simultaneously in external memory and load them only when required. This capability increases the effective logic density of the device, and lowers cost and power consumption.

In the Intel solution, you do not have to worry about intricate device architecture to perform a partial reconfiguration. The partial reconfiguration capability is built into the Intel Quartus Prime design software, making such time-intensive task simple.

Intel Arria 10 devices support partial reconfiguration in the following configuration options:

- Using an internal host:
 - All supported configuration modes where the FPGA has access to external memory devices such as serial and parallel flash memory.
 - Configuration via Protocol [CvP (PCIe)]
- Using an external host—passive serial (PS), fast passive parallel (FPP) x8, FPP x16, and FPP x32 I/O interface.

Enhanced Configuration and Configuration via Protocol

Table 25. Configuration Schemes and Features of Intel Arria 10 Devices

Intel Arria 10 devices support 1.8 V programming voltage and several configuration schemes.

| Scheme | Data Width | Max Clock Rate (MHz) | Max Data Rate (Mbps) (13) | Decompression | Design Security ⁽¹ 4) | Partial Reconfiguration (15) | Remote System Update |
|--|------------------|----------------------------|------------------------------------|---------------|--|------------------------------------|---|
| JTAG | 1 bit | 33 | 33 | _ | _ | Yes ⁽¹⁶⁾ | _ |
| Active Serial (AS) through the EPCQ-L configuration device | 1 bit, 4 bits | 100 | 400 | Yes | Yes | Yes ⁽¹⁶⁾ | Yes |
| Passive serial (PS) through CPLD or external microcontroller | 1 bit | 100 | 100 | Yes | Yes | Yes ⁽¹⁶⁾ | Parallel Flash Loader (PFL) IP core |
| | continued | | | | | | |

⁽¹³⁾ Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

⁽¹⁴⁾ Encryption and compression cannot be used simultaneously.

⁽¹⁵⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

⁽¹⁶⁾ Partial configuration can be performed only when it is configured as internal host.



| Scheme | Data Width | Max Clock Rate (MHz) | Max Data Rate (Mbps) | Decompression | Design Security ⁽¹ 4) | Partial Reconfiguration (15) | Remote System Update |
|--|----------------------------|----------------------------|----------------------------|---------------|--|------------------------------------|----------------------------|
| Fast passive | 8 bits | 100 | 3200 | Yes | Yes | Yes ⁽¹⁷⁾ | PFL IP |
| parallel (FPP) through CPLD or | 16 bits | | | Yes | Yes | | core |
| external microcontroller | 32 bits | | | Yes | Yes | | |
| Configuration via | 16 bits | 100 | 3200 | Yes | Yes | Yes ⁽¹⁷⁾ | _ |
| HPS | 32 bits | | | Yes | Yes | | |
| Configuration via Protocol [CvP (PCIe*)] | x1, x2, x4, x8 lanes | _ | 8000 | Yes | Yes | Yes ⁽¹⁶⁾ | _ |

You can configure Intel Arria 10 devices through PCIe using Configuration via Protocol (CvP). The Intel Arria 10 CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

SEU Error Detection and Correction

Intel Arria 10 devices offer robust and easy-to-use single-event upset (SEU) error detection and correction circuitry.

The detection and correction circuitry includes protection for Configuration RAM (CRAM) programming bits and user memories. The CRAM is protected by a continuously running CRC error detection circuit with integrated ECC that automatically corrects one or two errors and detects higher order multi-bit errors. When more than two errors occur, correction is available through reloading of the core programming file, providing a complete design refresh while the FPGA continues to operate.

The physical layout of the Intel Arria 10 CRAM array is optimized to make the majority of multi-bit upsets appear as independent single-bit or double-bit errors which are automatically corrected by the integrated CRAM ECC circuitry. In addition to the CRAM protection, the M20K memory blocks also include integrated ECC circuitry and are layout-optimized for error detection and correction. The MLAB does not have ECC.

Power Management

Intel Arria 10 devices leverage the advanced 20 nm process technology, a low 0.9 V core power supply, an enhanced core architecture, and several optional power reduction techniques to reduce total power consumption by as much as 40% compared to Arria V devices and as much as 60% compared to Stratix V devices.

⁽¹³⁾ Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

⁽¹⁴⁾ Encryption and compression cannot be used simultaneously.

⁽¹⁵⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

⁽¹⁷⁾ Supported at a maximum clock rate of 100 MHz.



| Date | Version | Changes |
|----------------|------------|---|
| December 2015 | 2015.12.14 | Updated the number of M20K memory blocks for Arria 10 GX 660 from 2133 to 2131 and corrected the total RAM bit from 48,448 Kb to 48,408 Kb. |
| | | Corrected the number of DSP blocks for Arria 10 GX 660 from 1688 to 1687 in the table listing floating-point arithmetic resources. |
| November 2015 | 2015.11.02 | • Updated the maximum resources for Arria 10 GX 220, GX 320, GX 480, GX 660, SX 220, SX 320, SX 480, and SX 660. |
| | | Updated resource count for Arria 10 GX 320, GX 480, GX 660, SX 320, SX 480, a SX 660 devices in Number of Multipliers in Intel Arria 10 Devices table. |
| | | Updated the available options for Arria 10 GX, GT, and SX. Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>. |
| June 2015 | 2015.06.15 | Corrected label for Intel Arria 10 GT product lines in the vertical migration figure. |
| May 2015 | 2015.05.15 | Corrected the DDR3 half rate and quarter rate maximum frequencies in the table that lists the memory standards supported by the Intel Arria 10 hard memory controller. |
| May 2015 | 2015.05.04 | Added support for 13.5G JESD204b in the Summary of Features table. Added support for 13.5G JESD204b in the Summary of Features table. |
| | | Added a link to Arria 10 GT Channel Usage in the Arria 10 GT Package Plan topic. |
| | | Added a note to the table, Maximum Resource Counts for Arria 10 GT devices. |
| | | Updated the power requirements of the transceivers in the Low Power Serial Transceivers topic. |
| January 2015 | 2015.01.23 | Added floating point arithmetic features in the Summary of Features table. |
| | | Updated the total embedded memory from 38.38 megabits (Mb) to 65.6 Mb. |
| | | Updated the table that lists the memory standards supported by Intel Arria 10 devices. |
| | | Removed support for DDR3U, LPDDR3 SDRAM, RLDRAM 2, and DDR2. Moved RLDRAM 3 support from hard memory controller to soft memory controller. RLDRAM 3 support uses hard PHY with soft memory controller. |
| | | Added soft memory controller support for QDR IV. |
| | | Updated the maximum resource count table to include the number of hard memory controllers available in each device variant. |
| | | Updated the transceiver PCS data rate from 12.5 Gbps to 12 Gbps. |
| | | Updated the max clock rate of PS, FPP x8, FPP x16, and Configuration via HPS from 125 MHz to 100 MHz. |
| | | Added a feature for fractional synthesis PLLs: PLL cascading. |
| | | Updated the HPS programmable general-purpose I/Os from 54 to 62. |
| September 2014 | 2014.09.30 | Corrected the 3 V I/O and LVDS I/O counts for F35 and F36 packages of Arria 10 GX. |
| | | Corrected the 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 570 and 660. |
| | | Removed 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 900 and 1150. The NF40 package is not available for Arria 10 GX 900 and 1150. |
| | | continued |

Intel® Arria® 10 Device Overview

A10-OVERVIEW | 2018.04.09



| Date | Version | Changes |
|---------------|------------|---|
| August 2014 | 2014.08.18 | Updated Memory (Kb) M20K maximum resources for Arria 10 GX 660 devices from 42,660 to 42,620. |
| | | Added GPIO columns consisting of LVDS I/O Bank and 3V I/O Bank in the Package Plan table. |
| | | Added how to use memory interface clock frequency higher than 533 MHz in the I/O vertical migration. |
| | | Added information to clarify that RLDRAM3 support uses hard PHY with soft memory controller. |
| | | Added variable precision DSP blocks support for floating-point arithmetic. |
| June 2014 | 2014.06.19 | Updated number of dedicated I/Os in the HPS block to 17. |
| February 2014 | 2014.02.21 | Updated transceiver speed grade options for GT devices in Figure 2. |
| February 2014 | 2014.02.06 | Updated data rate for Arria 10 GT devices from 28.1 Gbps to 28.3 Gbps. |
| December 2013 | 2013.12.10 | Updated the HPS memory standards support from LPDDR2 to LPDDR3. Updated HPS block diagram to include dedicated HPS I/O and FPGA Configuration blocks as well as repositioned SD/SDIO/MMC, DMA, SPI and NAND Flash with ECC blocks . |
| December 2013 | 2013.12.02 | Initial release. |